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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of
Miyazaki

Docket Number: TI-36833

Serial No.: 10/750,059

Art Unit: 2814

Filed: 12/30/2003

Examiner: Thao X Le

For: **SOLDER BALL PAD STRUCTURE**

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NAME OF INVENTOR(S): HIROSHI MIYAZAKI		RECEIPT DATE & SERIAL NO.: Serial No.: 10/750,059
TITLE OF INVENTION: SOLDER BALL PAD STRUCTURE		Conf. No: 9129
TI FILE NO.: TI-36833	DEPOSIT ACCT. NO.: 20-0668	
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